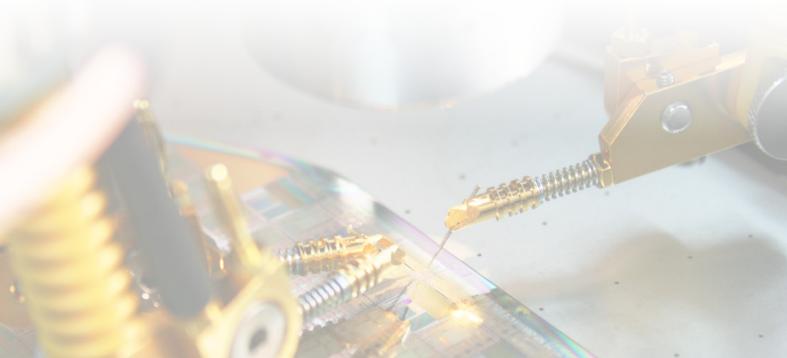




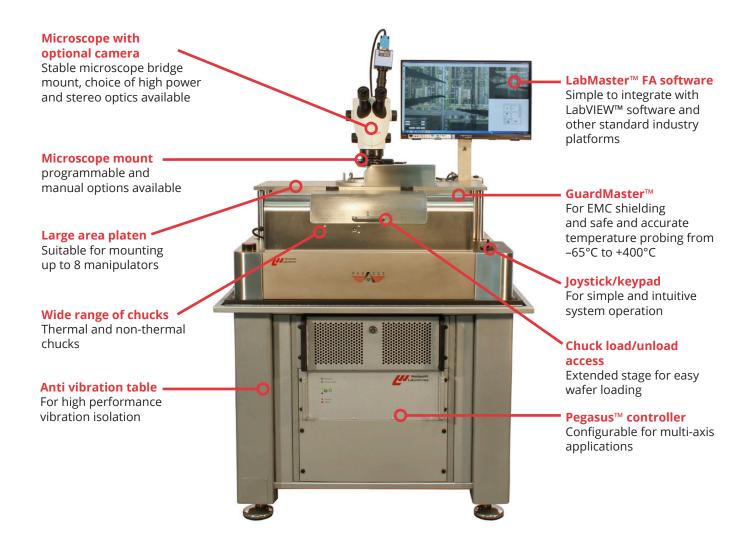
ANALYTICAL PROBERS

S200FA S300FA SEMI-AUTOMATIC



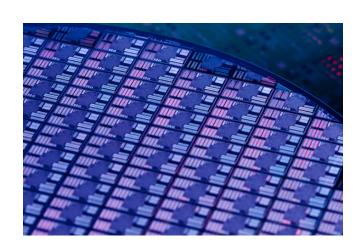


KEY FEATURES



DESIGNED FOR A WIDE RANGE OF APPLICATIONS

- Failure analysis
- Design verification
- Parametric testing
- ✓ Ideal for MEMS, HV/HC, RF and mmWave testing



THE DESIGN

HIGH PRECISION

All Wentworth probers feature a robust chassis for mounting the prober stage.

The **XY stage** uses high precision motors with microstepping for greater accuracy. Ultra-high precision ball-screws reduce back lash and improve accuracy and repeatability.

The **Z stage** uses ultra-high precision multi-point lift ball-screws for superior linear rigidity. Additional multi-point linear bearings ensure increased torsional stiffness.

All stages are controlled by the **Pegasus™ Controller** consisting of the drive electronics, joystick, keypad and optional Windows user interface.

Interfacing is made easy with TTL, GPIB (IEEE488.2), RS232 and ethernet ports located on the back panel.

| STAGE SPECIFICATIONS | | |
|----------------------|----------|--|
| Repeatability | 5.0 μm | |
| Accuracy | ± 5.0 μm | |

The Microscope Bridge is designed for strength and with standard PMM (Programmable Microscope Mount) as well as multiple Z axes PMM, which allows test equipment such as thermal cameras, spectrometers, integrating spheres, laser cutters and light sources to be independently controlled via the prober joystick functions. This feature allows the optics to be repositioned to enable direct device access from the top side.

EASE OF USE

The Pegasus™ S200FA and S300FA probers are designed with the operator in mind. Ergonomic controls make this one of the easiest prober platforms on the market today. Quick start up and simple menus allow users to be probing in minutes, whilst intuitive controls ensure that minimal operator training is required. The FA series probers can be used in 'local' or 'remote' mode. This flexibility allows the prober to be easily integrated with industry standard testers and data acquisition software, such as LabVIEW™.

Using either the stand alone joystick (with menu driven controls) or our windows based graphical interface LabMaster™ FA, this platform is an ideal choice for both universities and commercial users.

CONFIGURABLE DESIGN

The Pegasus™ S200FA and S300FA can be configured for a variety of applications at affordable cost. With over 50 years of experience serving the electronics industry, we can support even the most challenging application to be managed within standard lead times and budgets.

ROBUST MECHANICS

Using highest quality materials in its construction, the FA series probers provide an extremely stable platform for sub-micron probing and precision applications such as laser cutting.

Lightweight chucks and drive mechanics allow extremely fast probing with no loss of accuracy.



Pegasus™ S300FA semi-automatic probe station

ANALYTICAL FLEXIBILITY



Pegasus™ S200FA with GuardMaster™ for low signal and low temperature probing

FAILURE ANALYSIS

Failure analysis applications require mechanical versatility and adaptability to make multiple measurements. The Pegasus™ S200FA and S300FA have been designed with these aspects in mind. Our full range of failure analysis tools and options such as manipulator probe heads/ needles, laser-ready optics and control/monitoring analysis software offer a wide choice of upgrade paths to ensure your system can grow with your testing requirements.

THERMAL CHARACTERIZATION

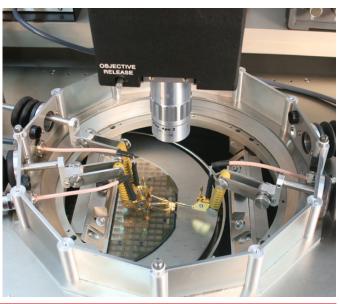
Our high performance thermal chuck solutions for device testing cover temperatures from -60°C to +400°C. To reduce thermal effects and keep the probing environment controlled, our propriety GuardMaster™ heating and cooling management system is an integral part of GuardMaster™, utilizing CDA or nitrogen.

| OPTIONS | |
|-----------------|---|
| Temperature | Control |
| -30°C to +400°C | Active air cooled chuck system |
| -60°C to +300°C | Air cooled high end system combining very low and high temperatures within one chuck system |
| -60°C to +300°C | Liquid cooled for high power applications |

Analytical flexibility is at the core of our products, as well as mechanical stability and accuracy. Different measurements require different test methods and cabling solutions. Therefore, our bespoke and standard tester solution packages are configured in an easy-to-use 'plug and play' set-up. Our LabMaster™ FA software has the ability to communicate with both the tester and the prober's associated accessories, offering real-time data analysis and data acquisition.

DYNAMIC TESTING

The Pegasus™ FA series probers include advanced utilities which allow the experienced user to design sophisticated test routines. These test routines may then be re-used for automated testing, saving time and increasing productivity. A 'quiet mode' option removes power to all motors to reduce the noise floor.



Pegasus™ S200FA with lower GuardMaster™ chamber

USER INTERFACE

LABMASTER™ CONTROL & MONITORING SOFTWARE

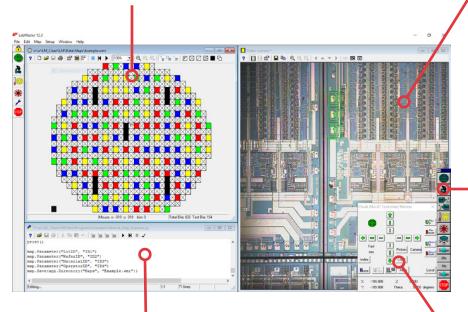
LabMaster™ FA is a simple-to-use Windows based graphical interface which allows real-time, fully integrated monitoring and control. It integrates with LabVIEW™ and other industry standard platforms and controls the Pegasus™ prober via either an RS232 interface or a GPIB (IEEE488.2) interface using the National Instruments PCI-GPIB board.

Wafer Map Window

Powerful failure analysis tool used for device navigation and positioning, as well as for displaying and storing die-binning information. Using the Wafer Map window, enables the user to quickly position the chuck to any die on the wafer. Wafer maps can be stored locally at the prober and saved as a simple text file (SINF - comma separated value), for easy transfer import/export.

Video Window

Displays real-time video from the camera attached to the microscope by using an overlay video board. Any image shown in the LabMaster™ FA video window can be saved to disk in a variety of image formats, or copied to the Windows clipboard for pasting into other Windows applications.



Device Toolbar

Contains the device buttons for controlling external devices such as the probe platform, programmable microscope mount (PMM), submicron automated manipulators (SAMs), thermal chucks, lasers and microscope auto zoom functions. The hardware setup dialogue box is used to add or remove devices from the toolbar. It can also be used to modify a device's hardware setup parameters.

Text Editor Window

Used to create, edit and run REXX and Python programs. Multiple edit windows can be open at any one time, allowing you to cut and paste text from one window to another. The edit window toolbar contains buttons for frequently used functions such as Open, Save, Run, Stop and Syntax Check.

Pegasus™ Motion Control Window

Used to control the motion of the prober's chuck, SAMs and the PMM. All can be controlled individually, and, in addition, the SAM and PMM can be moved together for in-die probing. The arrow buttons are used to index the prober the distance specified by the index step values entered using the probers setup dialogue box. Slow, medium and fast velocity function buttons allow easy navigation between different areas on the wafer.

OFFLINE TOOLS

The Wentworth Labs **Wafer Map Editor** is an offline editor/viewer for LabMaster™ compatible wafer map files and wafer map file templates. It allows for wafer map templates to be created and modified prior to being used for wafer testing. Wafer results files can also be viewed in this application and used to generate further template files.

LEADING EDGE APPLICATIONS

DC PARAMETRIC

Utilizing Wentworth's replaceable Pegasus™ probes or DC cantilever probe cards, the Pegasus™ S200FA and S300FA probers are an ideal platform for parametric testing. Tunable stage speeds and product enhancing accessories allow for fast probing and increased through-put, whilst chuck solutions enable probing of full wafers, shards, single chips and packaged devices.

| SPECIFICATIONS | | |
|--------------------------------------|---|--|
| Frequency | DC > 100Mhz | |
| Breakdown Voltage | 500 V | |
| Leakage (depending on configuration) | Down to \pm 10 fA -65°C > +200°C Down to \pm 20 fA +200°C > +400°C | |



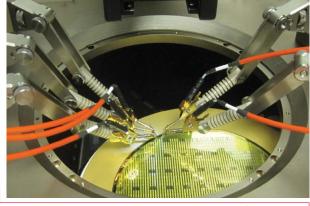
Analytical DC Test

HIGH POWER

A high power configuration addresses today's power semiconductor test challenges with low contact resistance measurements requiring accuracy at high voltages. Kelvin chucks and backside probing solutions allow contact resistance measurements in the milliohm range.

High current probes and probe cards (up to 100 A) handle and distribute excessive current loads. Dedicated HV and HC probes reduce probe and device destruction at high voltages/ currents by preventing arcing at the tip.

| SPECIFICATIONS | | |
|----------------|----------------------------|--|
| Voltage | 3 kV (triax), 10 kV (coax) | |
| Current | 200 Amps (pulsed) | |
| Leakage | <1 pA (3 kV) | |



High Power Test

OPTO ELECTRONICS

Our FA series probers can be specifically designed for production and analytical probing of semiconductor light-LEDs, laser diodes and optical MEMS devices.

Chuck solutions allow handling of full wafers, shards, single chips and packaged parts. The set-up can accommodate spectrometer probes, fibre optics, integrating spheres, glass chucks, thermal imaging cameras and more.

| SPECIFICATIONS | | |
|----------------------------|---|--|
| Speed | Up to 20 dies/sec (70,000/hr) | |
| Reverse emission | Glass chuck, DSP, back side | |
| Controllable contact force | Pegasus™ probe (open loop to prober Z -stage) | |



Opto Electronics Test

OPTIONS & ACCESSORIES

| MICROSCOPE MOUNTS | | | | | | |
|-------------------------------|-----------|---------------------------------|------------|----------------------------|---|---|
| Туре | Travel XY | Travel Z | Resolution | Drive | Recommended Microscope | Application |
| Manual stereozoom (MMM) | 50x50 mm | 50 mm* | 0.9 μm | High precision lead screws | Binocular or trinocular stereozoom microscope | General probing, pad sizes down to 50 μm x 50 μm |
| Manual high powered (MMM) | 50x50 mm | 75 mm quicklift + 50 mm** | 0.9 μm | High precision lead screws | Compound high mag objective microscope | Small geometry pad or line probing down to 1-2 µm |
| Programmable (PMM) | 50x50 mm | 100 mm + 50 mm** | 0.1 µm | Stepper motors | Compound high mag objective microscope | Small geometry pad or line probing down to 1-2 µm |

^{*}achieved through standard stereozoom focus arm

^{**} when using heavy duty focus block

| MICROSCOPES | | | |
|--------------------|-----------------------|--|--|
| Microscope Type | Models Available | Application | |
| Stereo zoom | Wentworth, Leica | Pad probing and internal features down to 5.0 μm | |
| High magnification | Mitutoyo FS-70 Series | Offers the most flexibility and options for features down to 0.5 μm | |
| Without eyepieces | A-Zoom Micro | Use with CCD or video systems. | |

| MANIPULATORS | | |
|--------------|---------------------------------|--|
| | Туре | TPI/Resolution/Travel |
| | PVX400 (vacuum or magnetic) | 50 TPI / 1.2 μ m/° / X = \pm 5 mm, Y = \pm 5 mm, Z = >5 mm |
| | PVX500-100 (vacuum or magnetic) | 100 TPI / 0.7 μ m/° / X = \pm 5 mm, Y = \pm 5 mm, Z = >5 mm |
| | PVX500-200 (vacuum or magnetic) | 200 TPI / 0.4 μ m/° / X = \pm 5 mm, Y = \pm 5 mm, Z = >5 mm |
| | SAM (programmable) | $0.1 \ \mu m/^{\circ} \ / \ X = 30 \ mm, \ Y = 30 \ mm, \ Z = 30 \ mm$ |

| COMMUNICATION INTERFACES | | |
|--------------------------|---|--|
| Туре | Vendors | |
| TTL | (2) 15-way D plugs each providing (4) TTL signal outputs & (8) TTL inputs | |
| RS232 | Serial 9-pin D connector | |
| GPIB (IEEE488.2) | 8-bit parallel multi-master interface bus | |
| Ethernet | 48-bit MAC address | |

| ACCESSORIES | |
|--|---|
| Probes: Triaxial, coaxial, low impedance, Kelvin, high power | Thermal chucks: Heating, cooling, fast ramp/cool times |
| Probe tips: Tungsten, Tungsten-Carbide, Be Cu, gold plated | Probe cards: Ceramic blade, epoxy cantilever, custom solutions |
| GuardMaster™: Combined light-tight and EMC shielded enclosure for low level measurements and frost-free low temperature probing | Automatic 2-point align: Provides system automation and fast device set-up routine |
| Manual Manipulator (PVX): Magnetic and vacuum options | Pattern recognition: Automatic die detection and probe to pad alignment |
| Programmable Computer Controlled Manipulators: For submicron and in die probing | Packaged device holders: Held down by vacuum on the chuck's surface |
| Pin Hole chucks: Designed for thin wafers <150 μm thick. Definable vacuum patterns and single device holders | Probe card holders: 4.5" and 6" low profile probe card holder (PCH) |
| Laser cutter: Laser ablation, depassivating, cutting and trimming | Chuck solutions: Standard, gold plated, waffle tray, single devices, interchangeable, glass, ceramic, double sided, Kelvin |
| Dark boxes: External open dark boxes with cable patch panels | Supplies: Vacuum pumps and air compressors |
| Camera and monitors: Facilitates contacting bond pads or taking images | LabMaster [™] Control and monitoring graphical user interface |
| Anti vibration tables: Robust anti vibration design for dampening external vibrations | Quiet Mode: Removes power to all motors to reduce the noise floor |
| Interface panels: Coax BNC, triax BNC, SHV, HV triax, D-SUB, SSMA, SMB, banana | Triaxial chucks: For reduced leakage and capacitance measurements |

SPECIFICATIONS

PEGASUS™ S200/S300FA SEMI-AUTOMATIC PROBE STATIONS

| | Pegasus™ S200FA | Pegasus™ S300FA |
|-------------------------------|---------------------|------------------|
| Chuck Stage | | |
| X-Y Stage | | |
| Precision ball-screw | vs & stepper motors | |
| Travel | 210 x 314 mm | 310 x 400 mm |
| Resolution | 0.312 μm | 0.312 μm |
| Repeatability | ± 4.0 μm | ± 4.0 μm |
| Accuracy | ± 5.0 μm | ± 5.0 μm |
| Planarity | 8.0 µm | 8.0 µm |
| Maximum speed | 100 mm/sec | 100 mm/sec |
| Z Stage | | |
| Precision ball-screw | vs & stepper motors | |
| Travel | 11 mm | 11 mm |
| Resolution | 0.156 μm | 0.156 μm |
| Repeatability | ± 1.0 µm | ± 1.0 μm |
| Theta Stage | | |
| Travel | ± 8.0° | ± 8.0° |
| Resolution | 0.0001° | 0.0001° |
| Programmable Microscope Mount | | |
| Stepper Motors | | |
| Travel | 50 x 50 x 100 mm | 50 x 50 x 100 mm |
| Resolution | 0.15 μm | 0.15 μm |
| Repeatability | ± 1.0 μm | ± 1.0 μm |
| Accuracy | ± 2.5 μm | ± 2.5 μm |

| | Pegasus™ S200FA | Pegasus™ S300FA | |
|--------------------------|--------------------------|-----------------------|--|
| Probe Platform | | | |
| Drive type | Stepper motors | Stepper motors | |
| Z Travel | 18 mm | 18 mm | |
| Material | Nickel plated steel | Nickel plated steel | |
| Graphical User Inte | erface | | |
| | Windo | ows 7, 8.1 and 10 | |
| Communication Int | terfaces | | |
| PC | TTL, RS232, GPIB (IE | EE488.2), ETHERNET | |
| Utilities | | | |
| Power | 100-240 VAC 5 | 0/60 Hz select 600V A | |
| Vacuum | 0.5 cfm @20" Hg (min) | | |
| Compressed air | | 4 bar min | |
| Dimensions (w x d | x h) | | |
| Prober (excludes optics) | 840 x 842 x 610 mm | 880 x 875 x 610 mm | |
| Controller | 450 x 480 : (17.5 x 1 | | |
| Shielding | | | |
| Light | | > 120 db | |
| EMI | > 20 db 0.05 - 0.5 | Ghz, 30 db 0.5 - 3Ghz | |
| Weight | | | |
| Prober | 155 kg | 190 kg | |
| Controller | 13 kg | 13 kg | |

ABOUT WENTWORTH LABORATORIES

With over 50 years experience in wafer probing technology, our solutions are the number one choice for many leading-edge wafer test applications across the globe.

With the support of a world-wide network of representatives, we enable our customers to fulfil even the most challenging wafer probing goals, maximizing their productivity and reducing costs.

We look forward to discussing your wafer probing requirements.

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